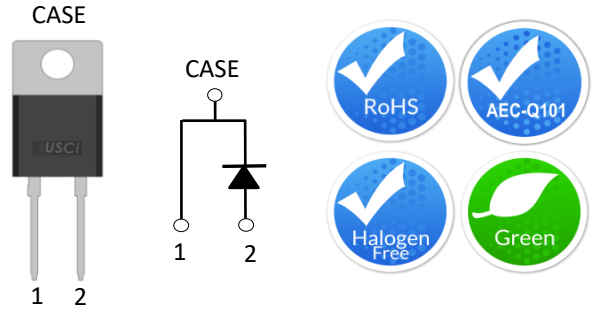


Description

United Silicon Carbide, Inc. offers the 3rd generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and 175°C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.



| Part Number | Package | Marking |
|-------------|-----------|-------------|
| UJ3D06506TS | TO-220-2L | UJ3D06506TS |

Features

- ◆ 175°C maximum operating junction temperature
- ◆ Easy paralleling
- ◆ Extremely fast switching not dependent on temperature
- ◆ No reverse or forward recovery
- ◆ Enhanced surge current capability, MPS structure
- ◆ Excellent thermal performance, Ag sintered
- ◆ 100% UIS tested
- ◆ AEC-Q101 qualified

Typical Applications

- ◆ Power converters
- ◆ Industrial motor drives
- ◆ Switching-mode power supplies
- ◆ Power factor correction modules

Maximum Ratings

| Parameter | Symbol | Test Conditions | Value | Units |
|---|----------------|--|------------|----------------------|
| DC blocking voltage | V_R | | 650 | V |
| Repetitive peak reverse voltage, $T_J=25^\circ\text{C}$ | V_{RRM} | | 650 | V |
| Surge peak reverse voltage | V_{RSM} | | 650 | V |
| Maximum DC forward current | I_F | $T_C = 153^\circ\text{C}$ | 6 | A |
| Non-repetitive forward surge current sine halfwave | I_{FSM} | $T_C = 25^\circ\text{C}, t_p = 10\text{ms}$ | 45 | A |
| | | $T_C = 110^\circ\text{C}, t_p = 10\text{ms}$ | 39 | |
| Repetitive forward surge current sine halfwave, $D=0.1$ | I_{FRM} | $T_C = 25^\circ\text{C}, t_p = 10\text{ms}$ | 29.5 | A |
| | | $T_C = 110^\circ\text{C}, t_p = 10\text{ms}$ | 17.9 | |
| Non-repetitive peak forward current | $I_{F,max}$ | $T_C = 25^\circ\text{C}, t_p = 10\mu\text{s}$ | 320 | A |
| | | $T_C = 110^\circ\text{C}, t_p = 10\mu\text{s}$ | 320 | |
| i^2t value | $\int i^2 dt$ | $T_C = 25^\circ\text{C}, t_p = 10\text{ms}$ | 10.1 | A^2s |
| | | $T_C = 110^\circ\text{C}, t_p = 10\text{ms}$ | 7.6 | |
| Power dissipation | P_{Tot} | $T_C = 25^\circ\text{C}$ | 93.4 | W |
| | | $T_C = 153^\circ\text{C}$ | 13.4 | |
| Maximum junction temperature | $T_{J,max}$ | | 175 | $^\circ\text{C}$ |
| Operating and storage temperature | T_J, T_{STG} | | -55 to 175 | $^\circ\text{C}$ |
| Soldering temperatures, wavesoldering only allowed at leads | T_{sold} | 1.6mm from case for 10s | 260 | $^\circ\text{C}$ |

Electrical Characteristics

$T_J = +25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Test Conditions | Value | | | Units |
|--|--------|--|-------|------|------|---------------|
| | | | Min | Typ | Max | |
| Forward voltage | V_F | $I_F=6\text{A}, T_J=25^\circ\text{C}$ | - | 1.5 | 1.7 | V |
| | | $I_F=6\text{A}, T_J=150^\circ\text{C}$ | - | 1.8 | 2.1 | |
| | | $I_F=6\text{A}, T_J=175^\circ\text{C}$ | - | 1.9 | 2.25 | |
| Reverse current | I_R | $V_R=650\text{V}, T_J=25^\circ\text{C}$ | - | 0.7 | 40 | μA |
| | | $V_R=650\text{V}, T_J=175^\circ\text{C}$ | - | 6 | | |
| Total capacitive charge ⁽¹⁾ | Q_C | $V_R=400\text{V}$ | | 14.5 | | nC |
| Total capacitance | C | $V_R=1\text{V}, f=1\text{MHz}$ | | 196 | | pF |
| | | $V_R=300\text{V}, f=1\text{MHz}$ | | 24 | | |
| | | $V_R=600\text{V}, f=1\text{MHz}$ | | 21 | | |
| Capacitance stored energy | E_C | $V_R=400\text{V}$ | | 2.2 | | μJ |

(1) Q_C is independent on T_J , di_F/dt , and I_F as shown in the application note USCi_AN0011.

Thermal characteristics

| Parameter | symbol | Test Conditions | Value | | | Units |
|-------------------------------------|-----------------|-----------------|-------|-----|-----|---------------------------|
| | | | Min | Typ | Max | |
| Thermal resistance, junction - case | $R_{\theta JC}$ | | | 1.2 | 1.6 | $^\circ\text{C}/\text{W}$ |

Typical Performance

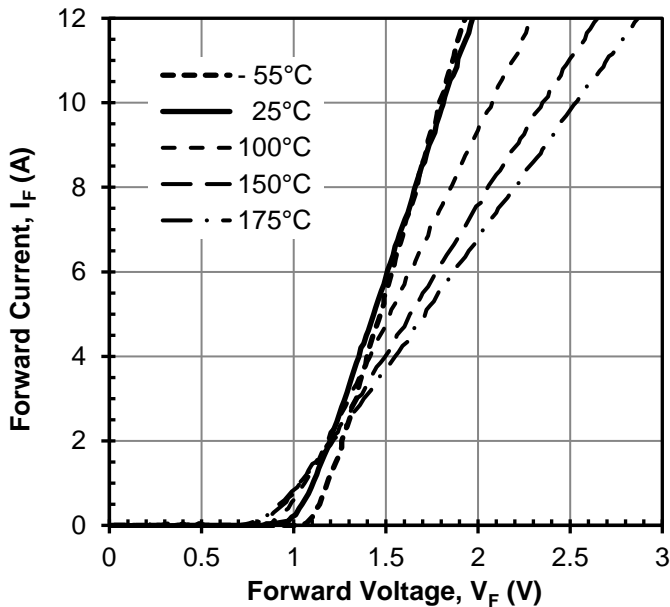


Figure 1 Typical forward characteristics

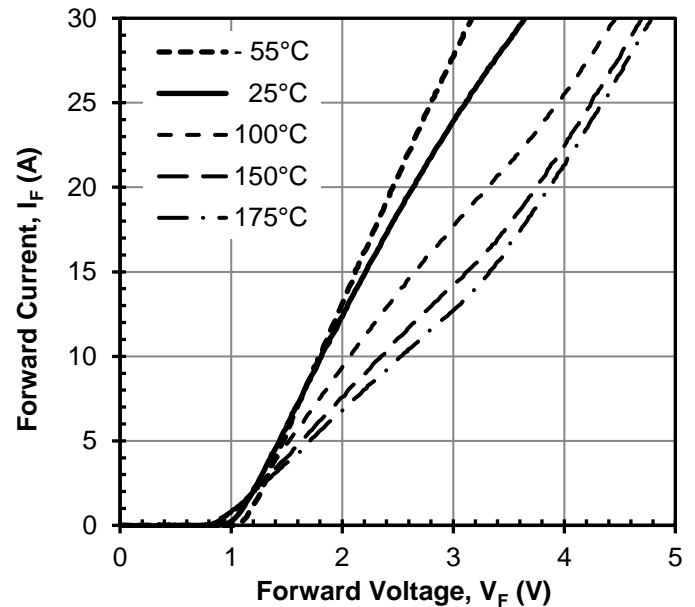


Figure 2 Typical forward characteristics in surge current

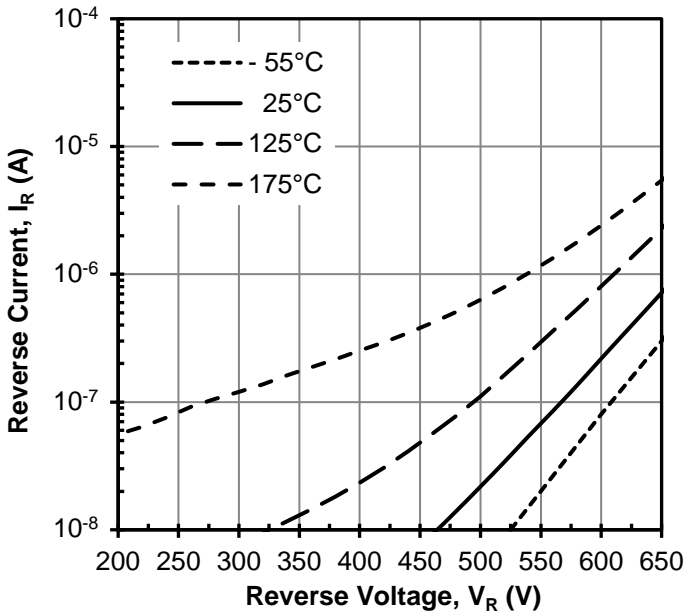


Figure 3 Typical reverse characteristics

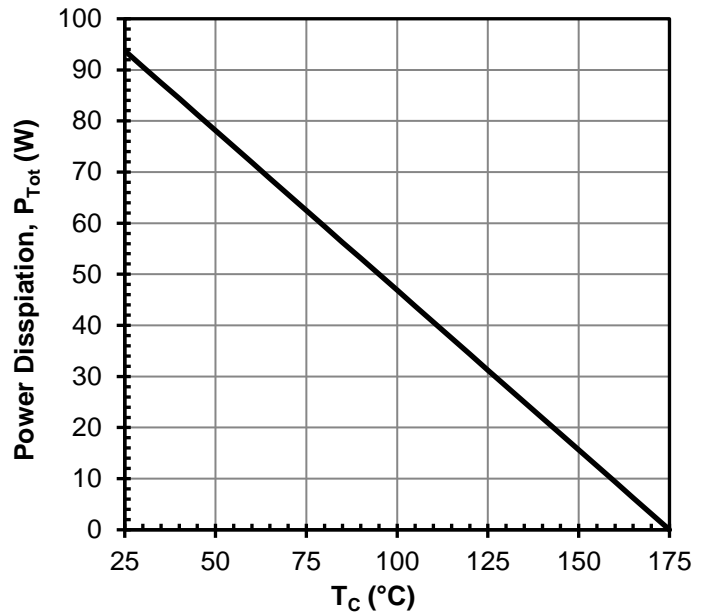


Figure 4 Power dissipation

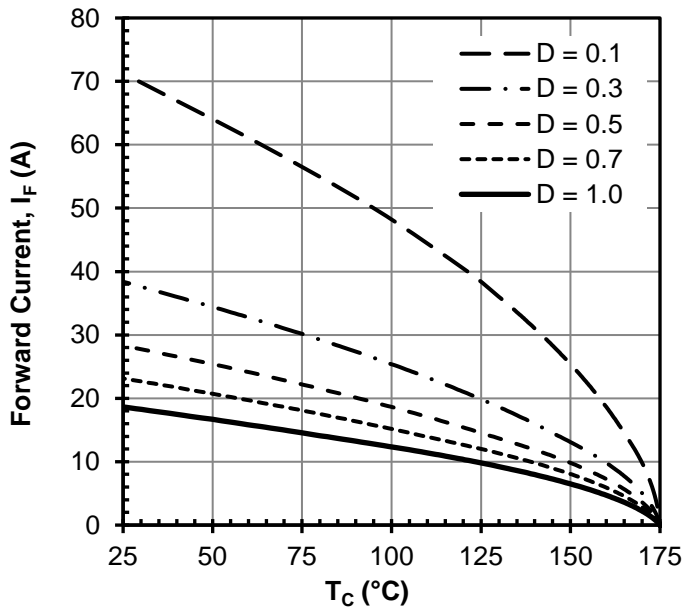


Figure 5 Diode forward current

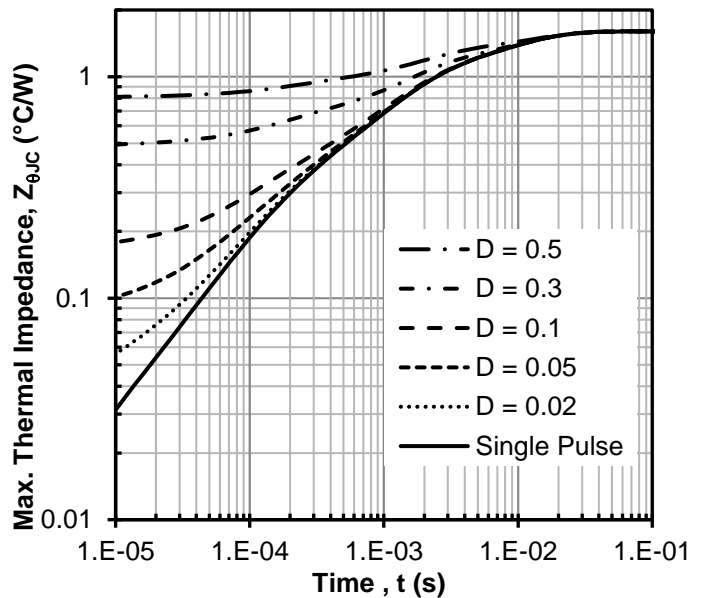


Figure 6 Maximum transient thermal impedance

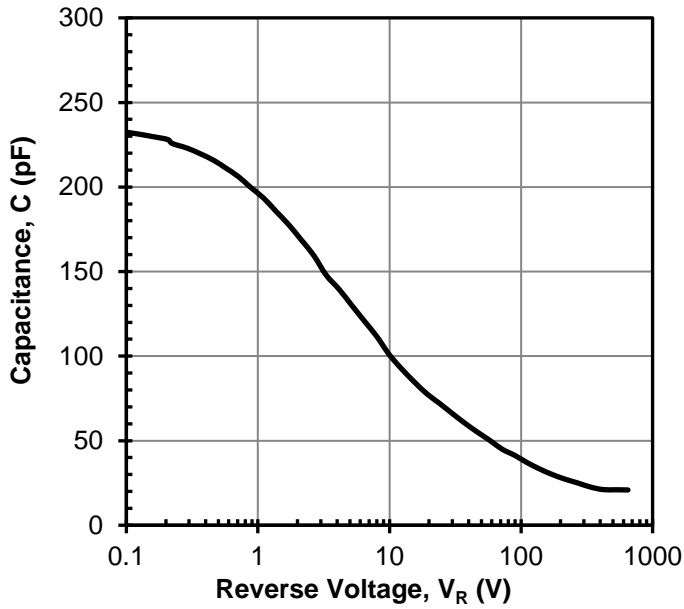


Figure 7 Capacitance vs. reverse voltage at 1MHz

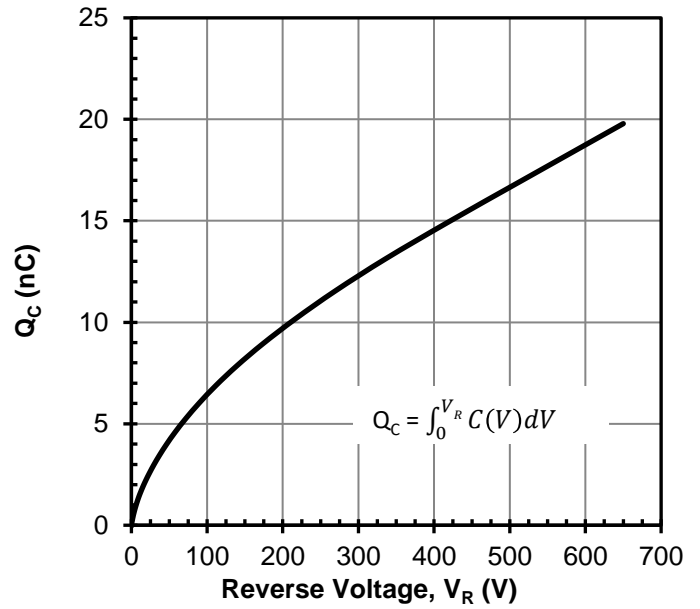


Figure 8 Typical capacitive charge vs. reverse voltage

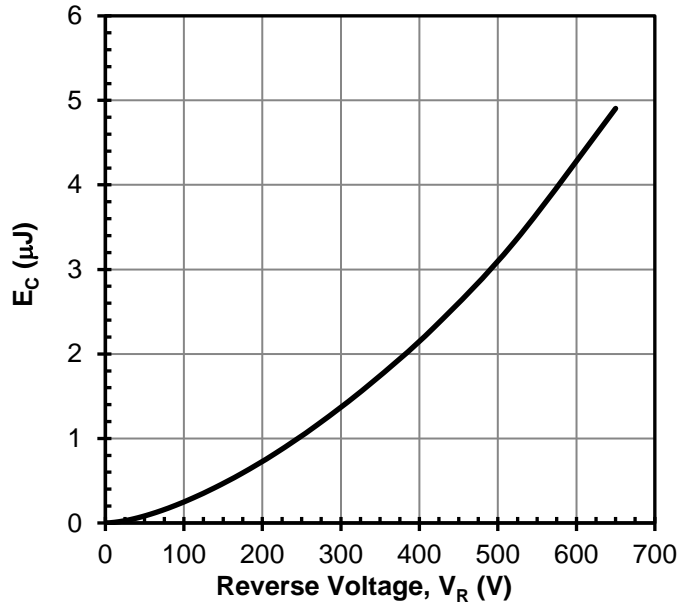


Figure 9 Typical capacitance stored energy vs. reverse voltage

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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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